

Fig. 3-12 The conduction band edge profiles from source to drain for different positions along the y direction. L=20nm.

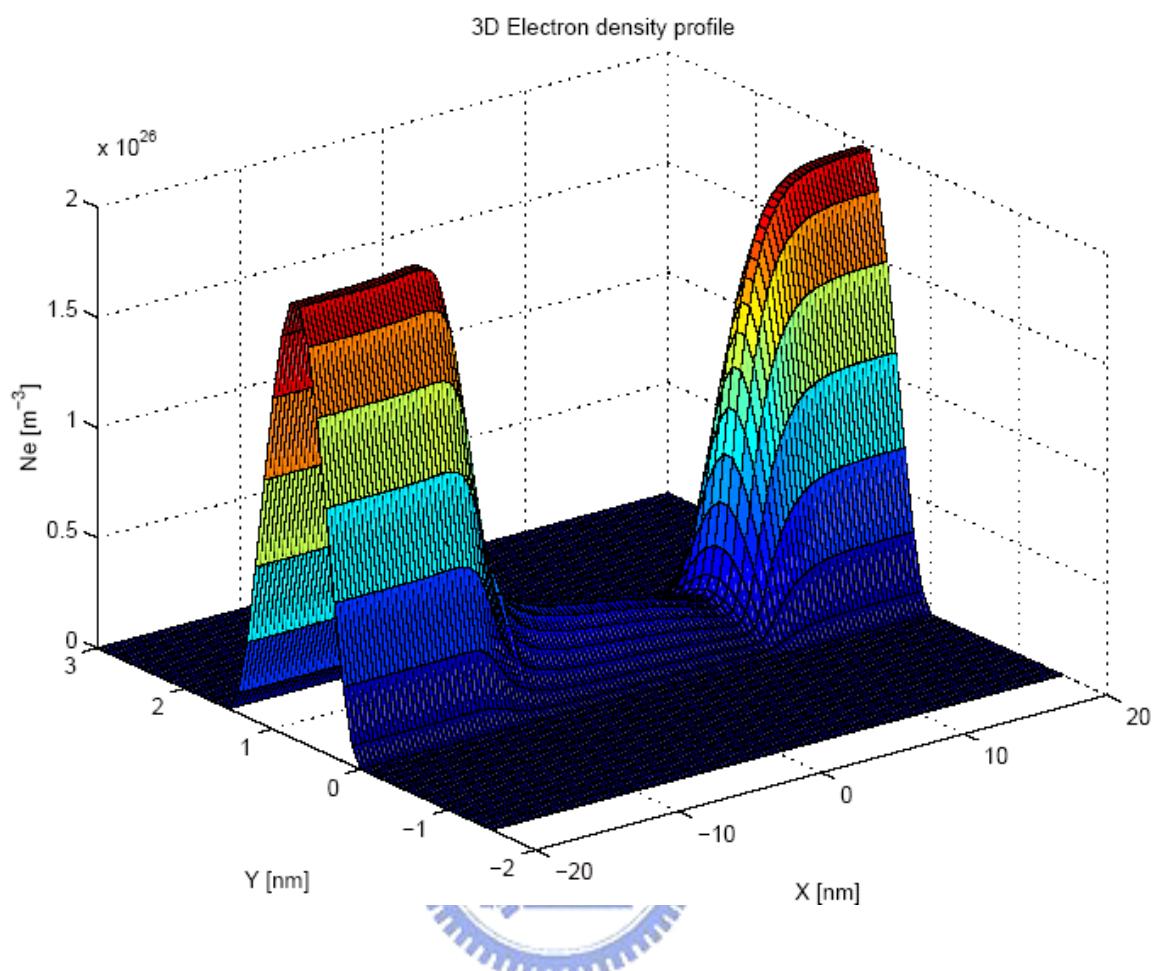


Fig. 3-13 3-D view of electron density profile. L=20nm.

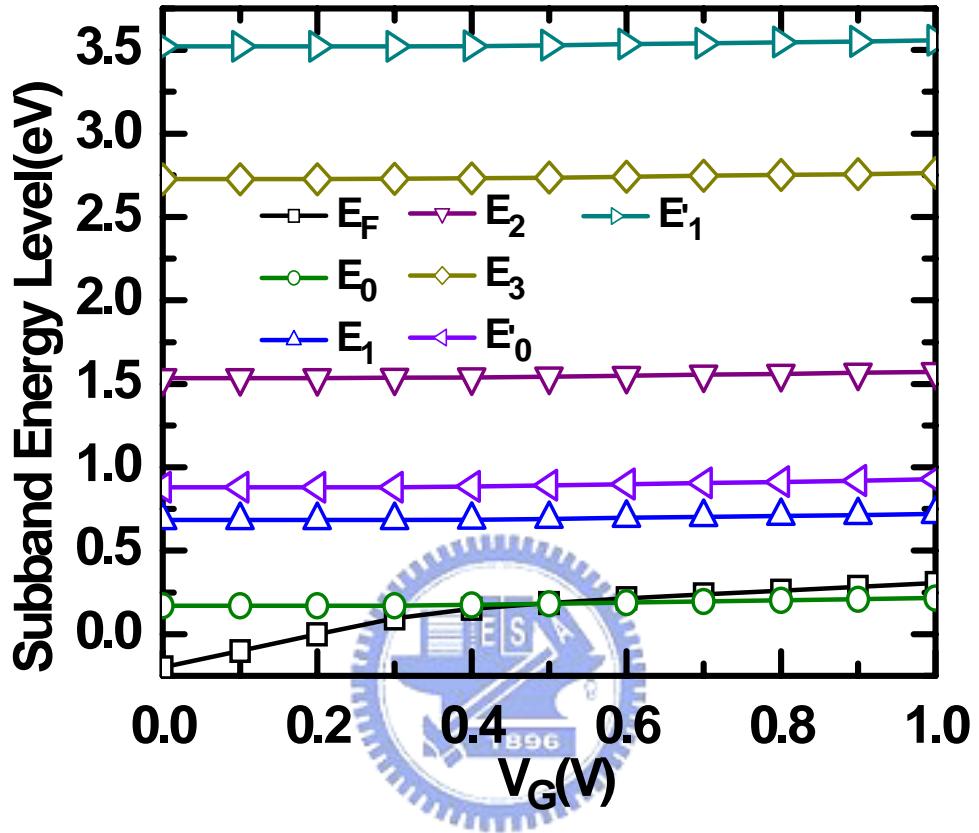


Fig. 4-1 Channel subband levels and Fermi level versus gate voltage obtained from 1-D self-consistent Schrödinger-Poisson simulation.

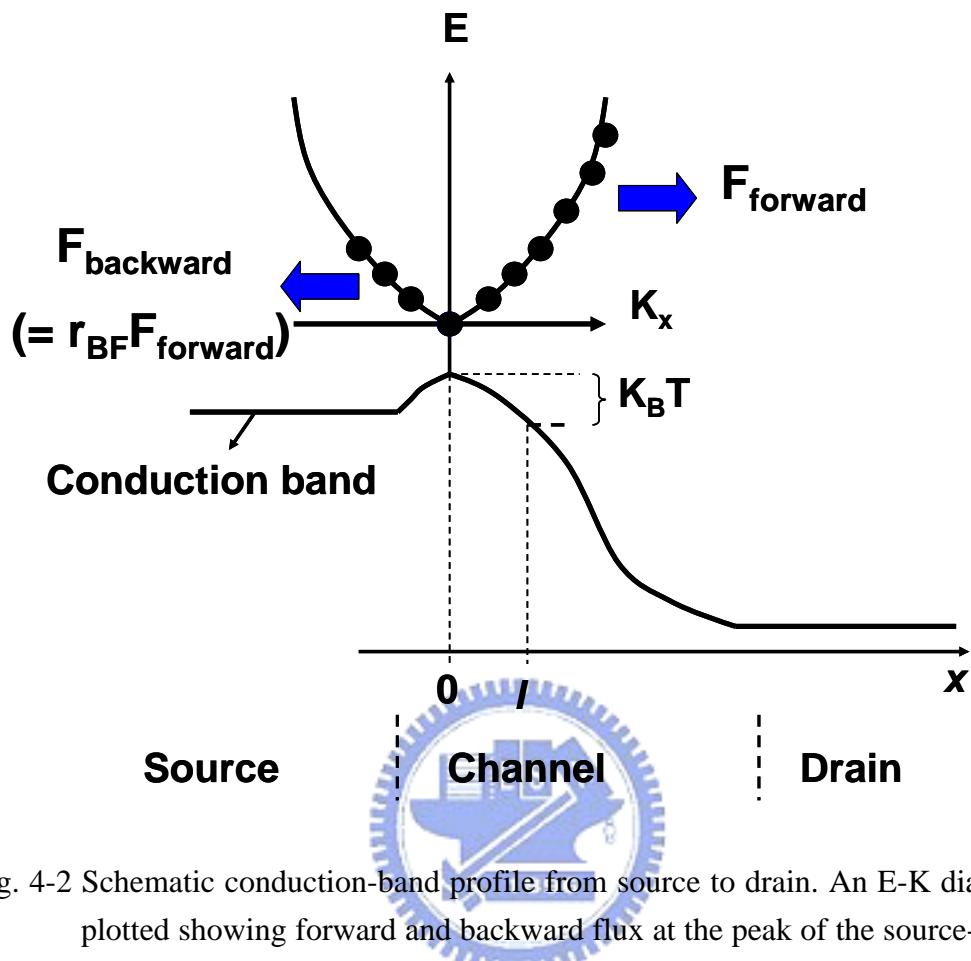


Fig. 4-2 Schematic conduction-band profile from source to drain. An E-K diagram is plotted showing forward and backward flux at the peak of the source-channel barrier.

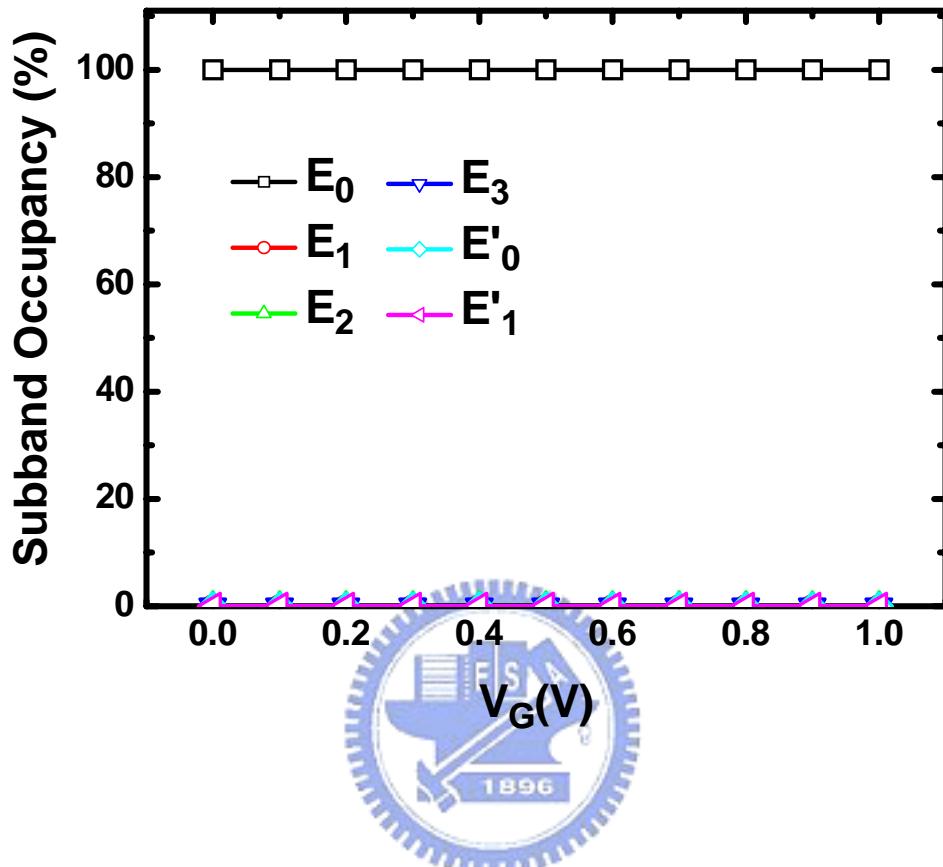


Fig. 4-3 Channel subband level occupancy versus gate voltage obtained from 1-D self-consistent Schrödinger-Poisson simulation.

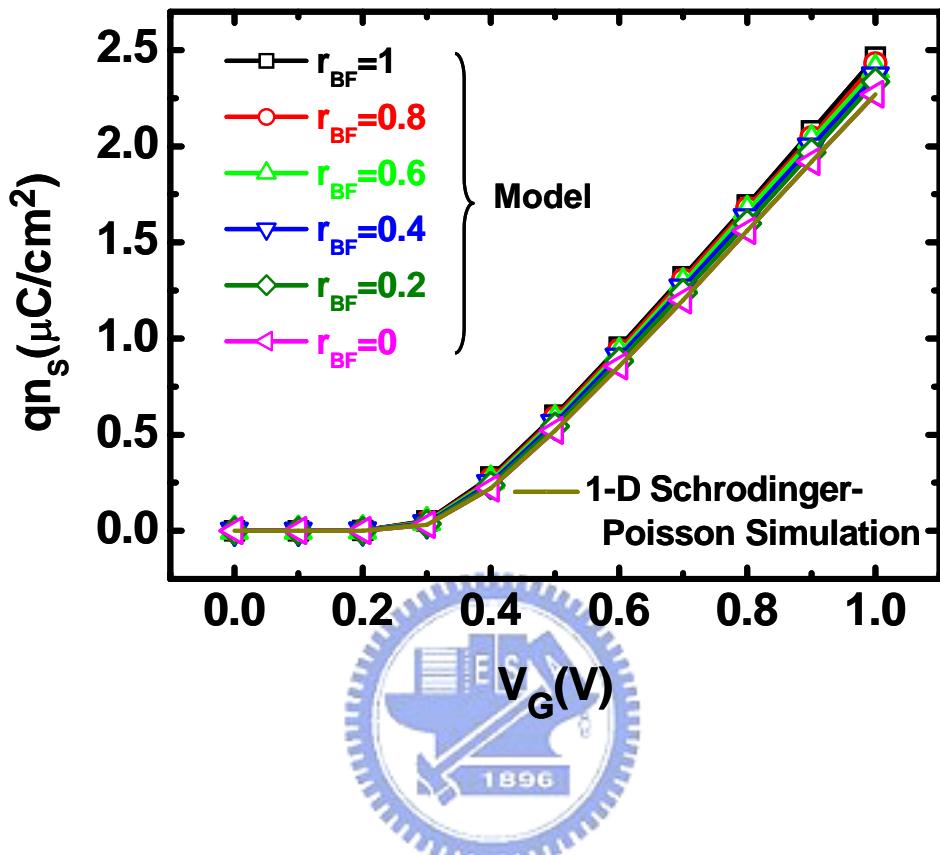


Fig. 4-4 Comparison of calculated inversion-layer charge versus gate voltage for different r_{BF} with equilibrium value ($r_{BF} = 1$) from Schrödinger-Poisson simulation.

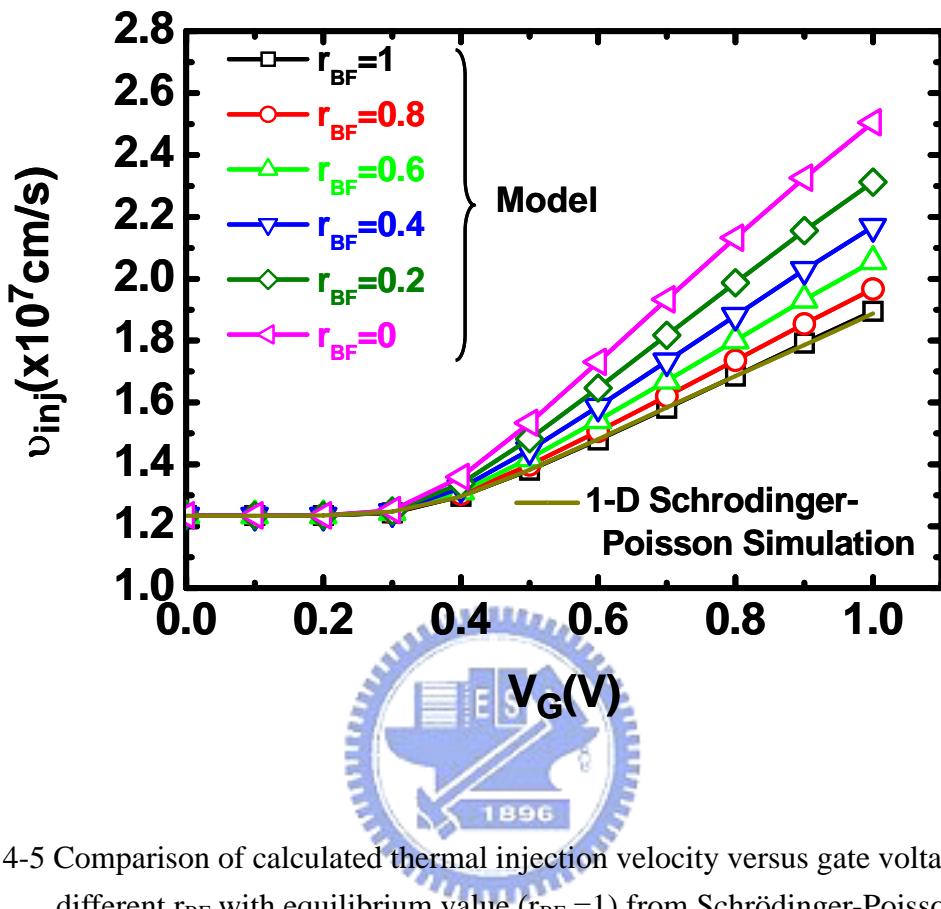


Fig. 4-5 Comparison of calculated thermal injection velocity versus gate voltage for different r_{BF} with equilibrium value ($r_{BF} = 1$) from Schrödinger-Poisson simulation.

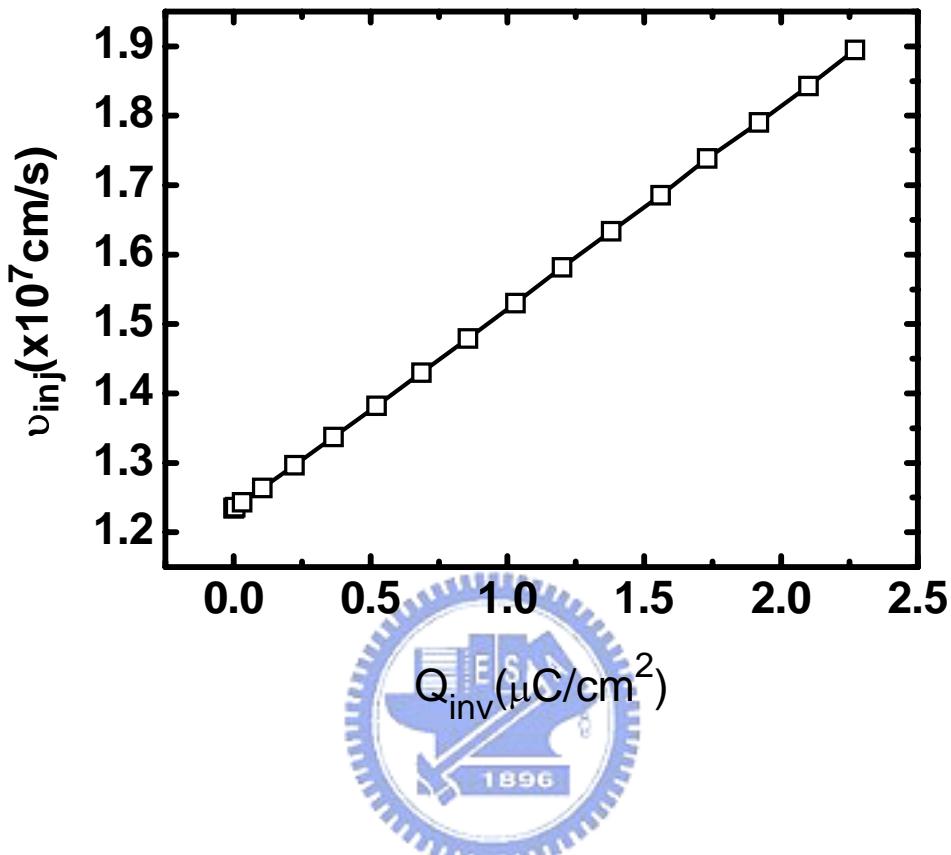


Fig. 4-6 Thermal injection velocity versus inversion-layer charge from Schrödinger - Poisson simulation.

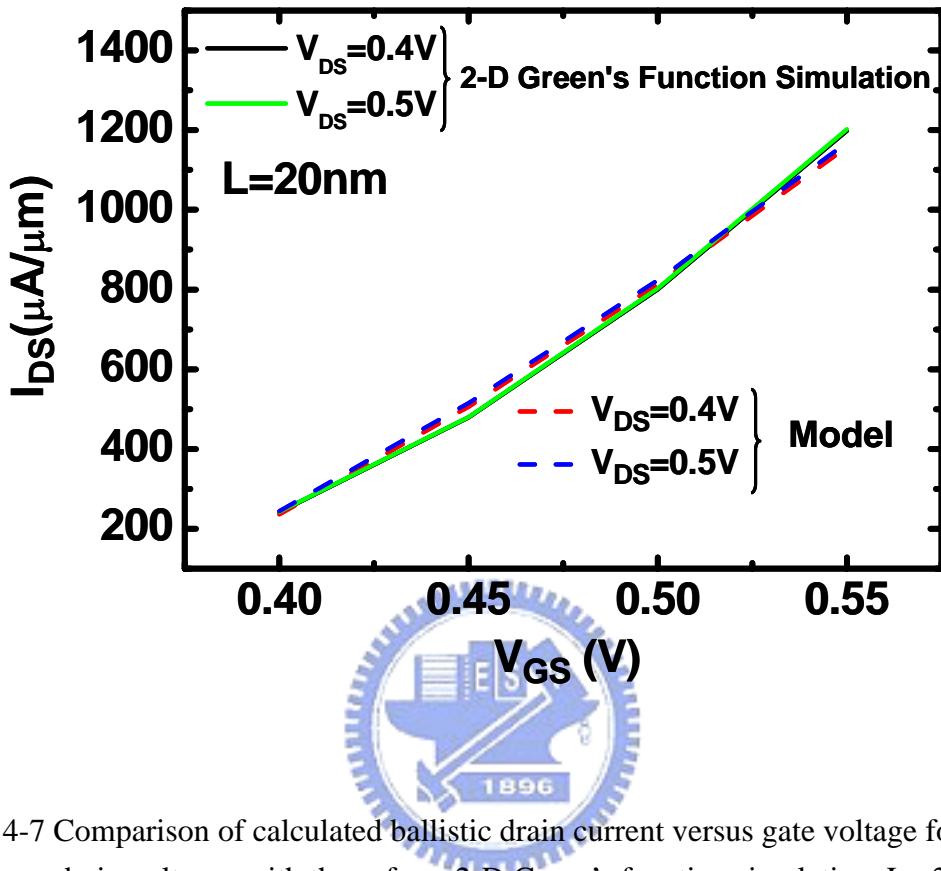


Fig. 4-7 Comparison of calculated ballistic drain current versus gate voltage for two drain voltages with those from 2-D Green's function simulation. L= 20 nm.

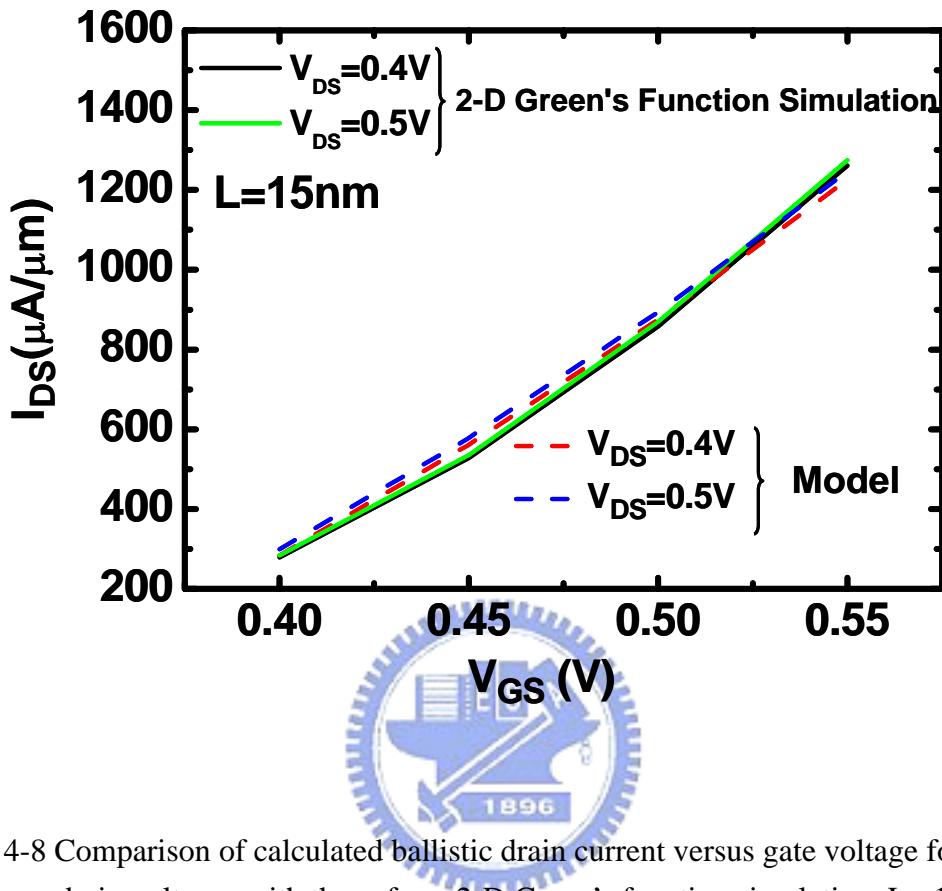


Fig. 4-8 Comparison of calculated ballistic drain current versus gate voltage for two drain voltages with those from 2-D Green's function simulation. $L = 15 \text{ nm}$.

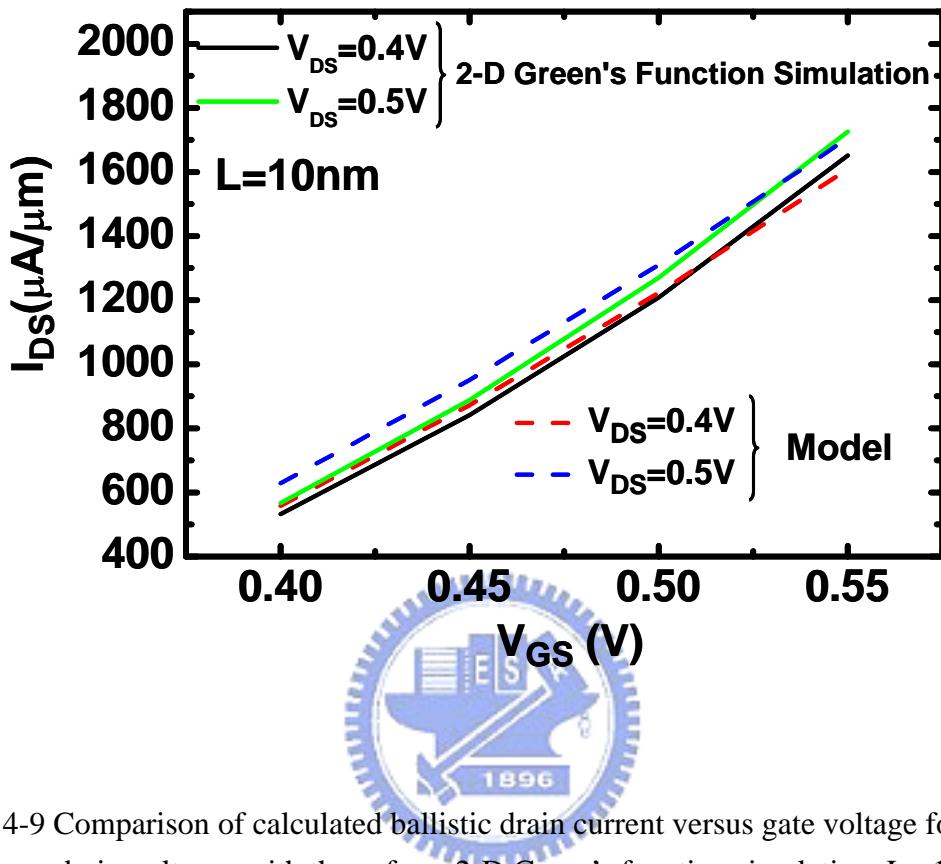


Fig. 4-9 Comparison of calculated ballistic drain current versus gate voltage for two drain voltages with those from 2-D Green's function simulation. $L = 10 \text{ nm}$.

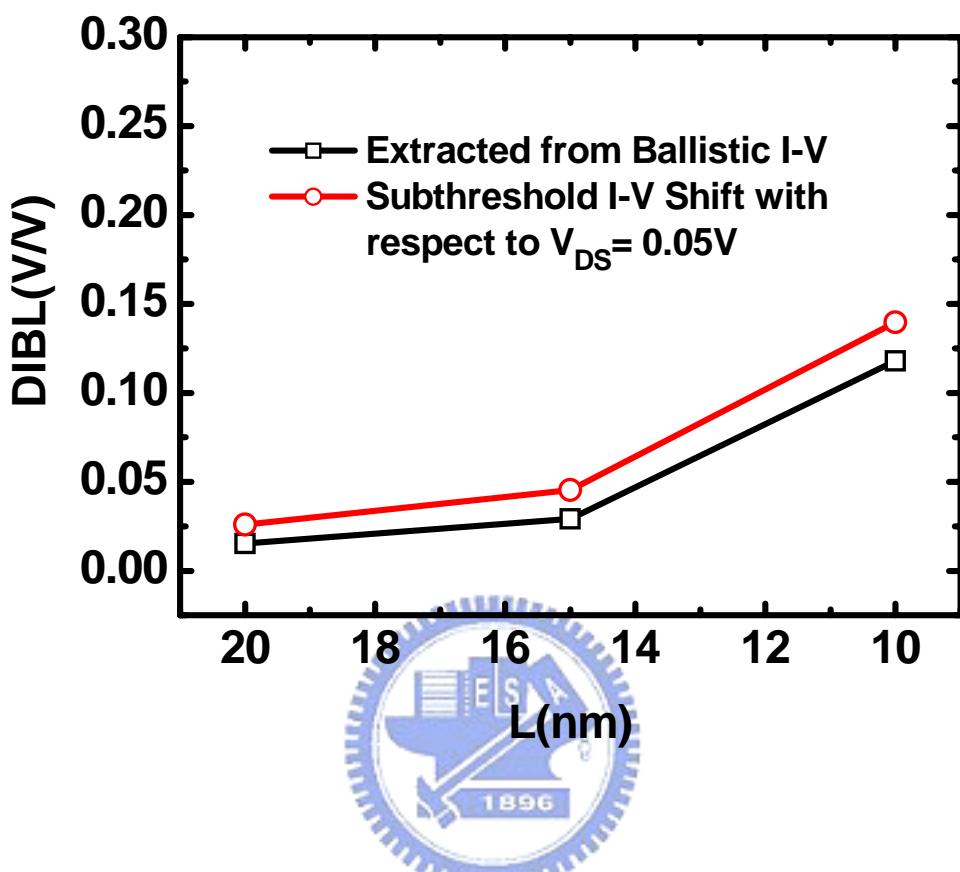


Fig. 4-10 Comparison of extracted DIBL with that from subthreshold I-V shift.

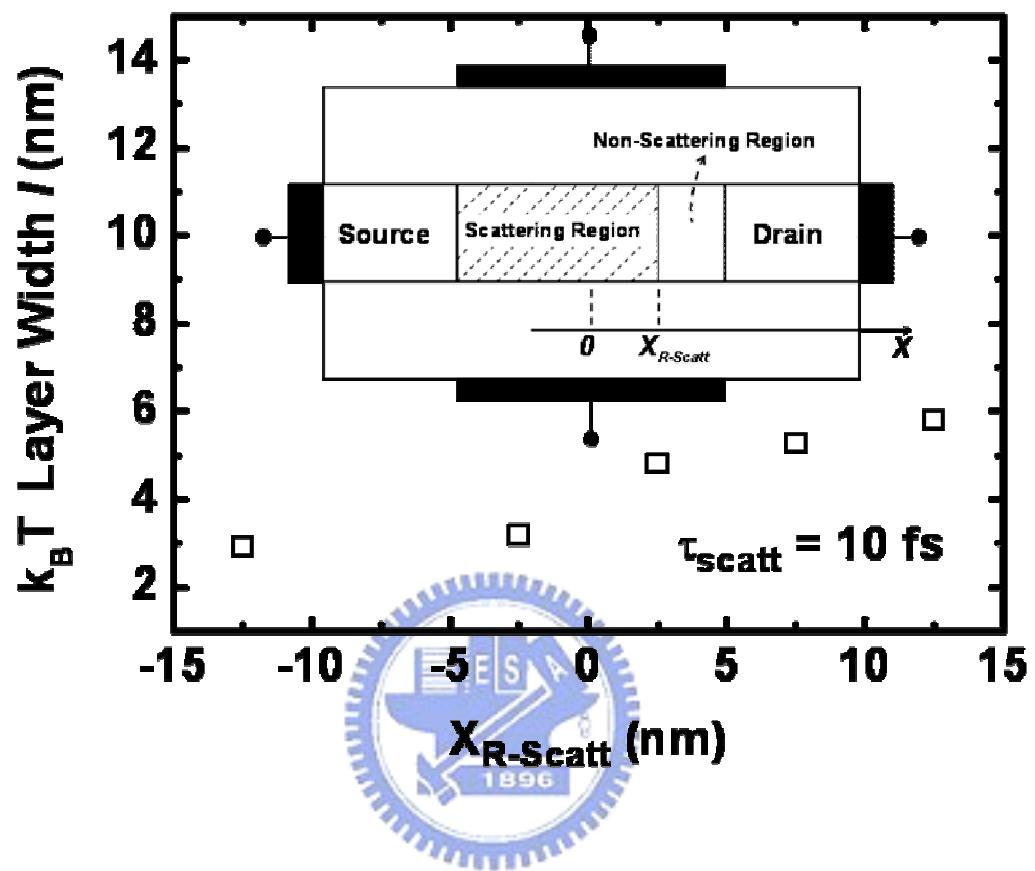


Fig. 4-11 $k_B T$ layer width versus $X_{R-Scatt}$ as quoted from [4] for $L = 25 \text{ nm}$. The inset shows the definition of $X_{R-Scatt}$.

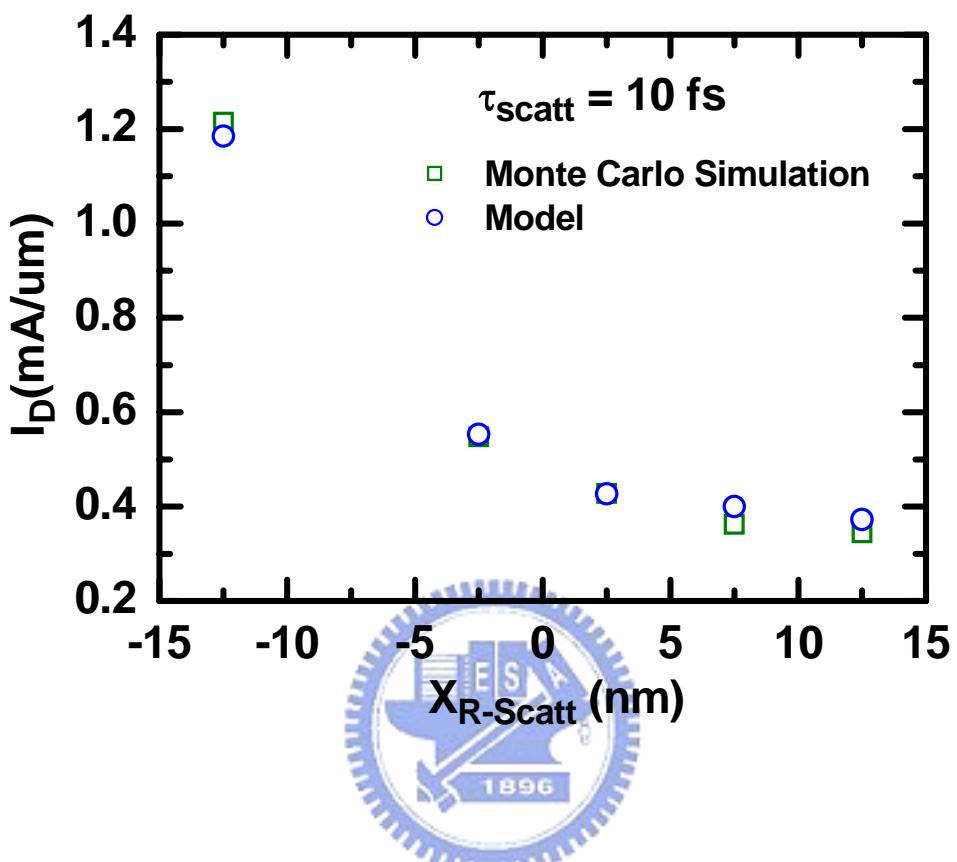


Fig. 4-12 Comparison of calculated drain current versus $X_{R-\text{Scatt}}$ with that from Monte Carlo simulation.

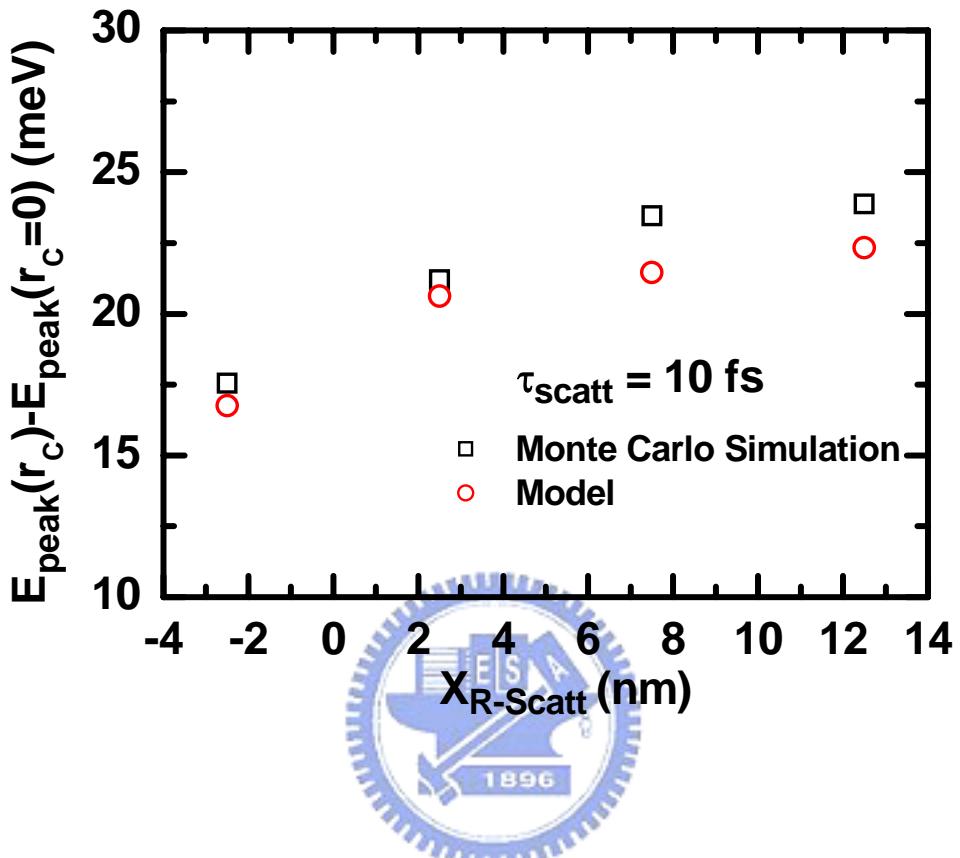


Fig. 4-13 Comparison of calculated and simulated difference in the peak of the source-channel barrier with respect to the ballistic case.

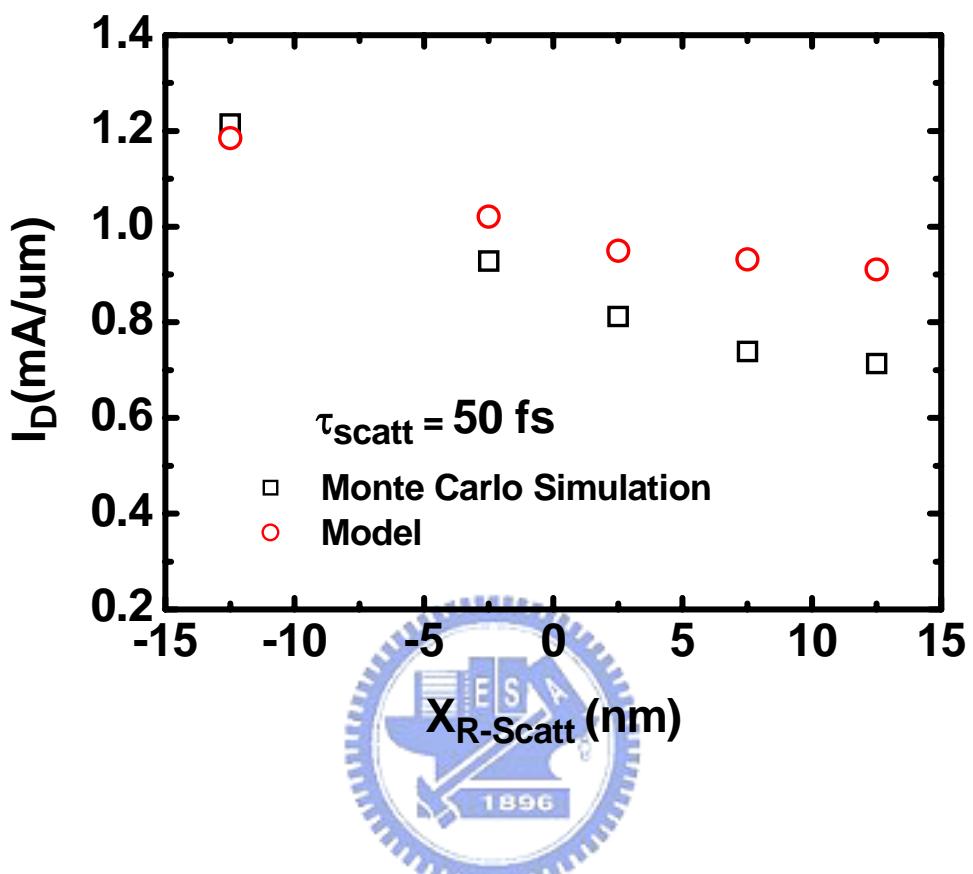


Fig. 4-14 Comparison of calculated drain current versus $X_{R-\text{Scatt}}$ with that from Monte Carlo simulation.

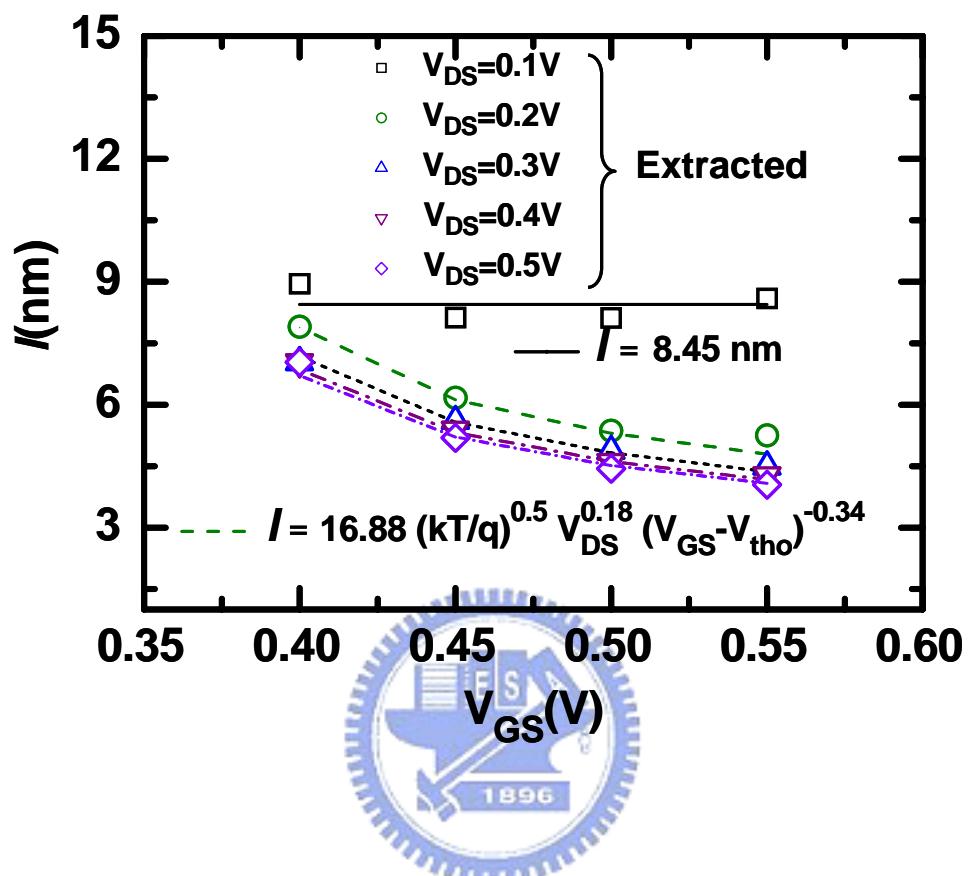


Fig. 4-15 Extracted (symbols) $k_B T$ layer width versus gate voltage for different drain voltages. The lines are from the $k_B T$ layer width expression.

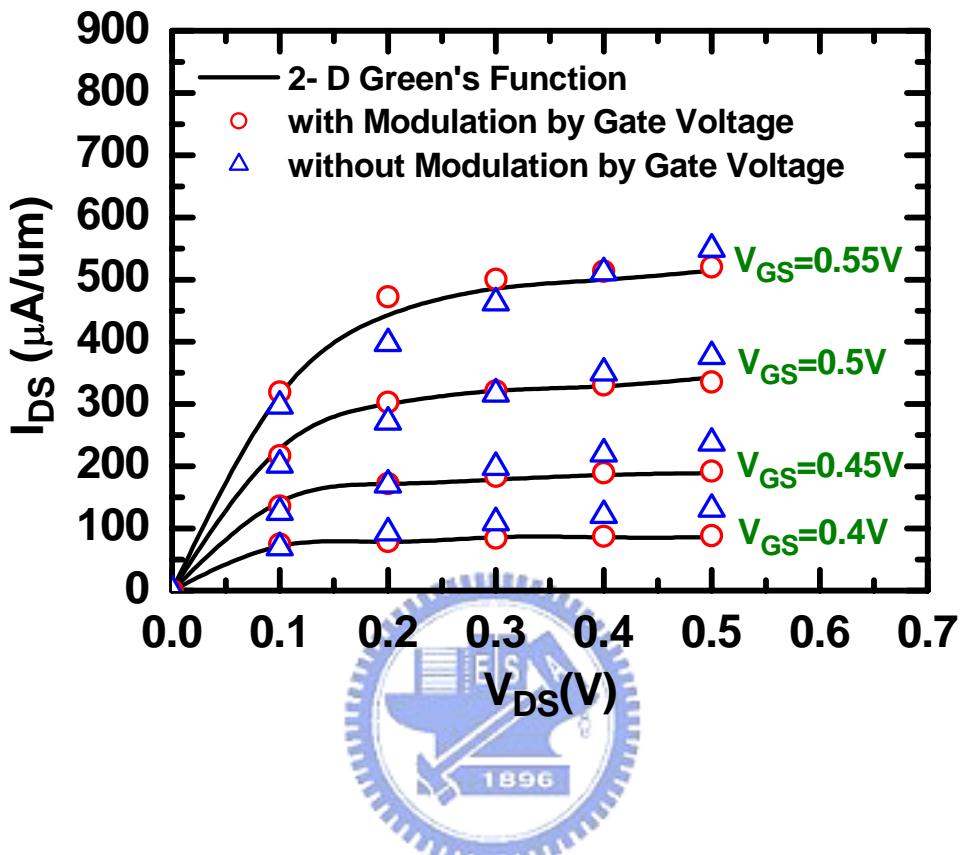


Fig.4-16 Comparison of simulated output I-V characteristics with those from compact model with and without the modulation by gate voltage. $L = 20 \text{ nm}$.